

AMCA72-2R470G-S1F

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7.0 x 2.0 x 1.0 mm **RoHS/RoHS II Compliant** MSL Level = 1

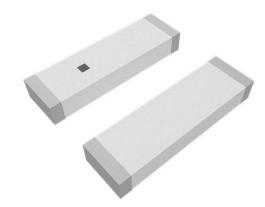
Features

- Miniaturized in size: 7 x 2 x 1 mm
- Compact & Low-Profile
- Low return loss of: ≤ -13.9 dB
- Peak Gain: 3.3 dBi
- Average Total Efficiency: -0.4 dB (92%)
- Linear Polarization
- Surface Mount (SMD)

Applications

- Bluetooth® / ZigBee® / Thread / Matter / Wi-Fi®
- Bluetooth® / Wi-Fi® Modules
- Consumer Hearables & Wearables
- Medical Wearables & Tele-Medicine
- Smart Home & Smart Building
- Asset Tracking & Telematics
- **Smart Metering**
- Intelligent Lighting
- Wireless Remote Control

Product Image







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Electrical Specification

Parameter	Specification	Unit
Operating Frequency	2400 - 2500	MHz
Return Loss	≤-13.9	dB
VSWR	≤ 1.5	:1
Polarization	Linear	-
Peak Gain	3.3	dBi
Minimum Total Efficiency	-0.6 (88)	dB (%)
Average Total Efficiency	-0.4 (92)	dB (%)
Maximum Total Efficiency	-0.2 (95)	dB (%)
Impedance	50	Ω
Radiation Pattern	Omni-directional	-
Input Power	< 3	W

Note: All measurements were performed using the evaluation board "AMCA72-2R470G-S1F-EVB" in a free-space environment. Actual performance may vary depending on factors such as the ground plane, specific application, and surrounding environment.

Mechanical Specification

Parameter	Specification	
Antenna Dimension	7.0 x 2.0 x 1.0 mm	
Evaluation board Dimension	51 x 18 mm	
Recommended Ground Clearance for Antenna	18 x 9.5 mm	
Mounting Type	Surface Mount	
Material(s)	Ceramic	

Environmental Specification

Parameter	Specification
Operating and Storage Temperature (individual chip without packing)	-40°C to +85°C
Packaging Storage Temperature	-10°C to +40°C
Packaging Storage Relative Humidity	70% (Max.)

Ordering Information

Part Number	Description
AMCA72-2R470G-S1F	Antenna Component on Cut Tape
AMCA72-2R470G-S1F-T4	Antenna Component on Tape & Reel
AMCA72-2R470G-S1F-EVB	Evaluation Kit





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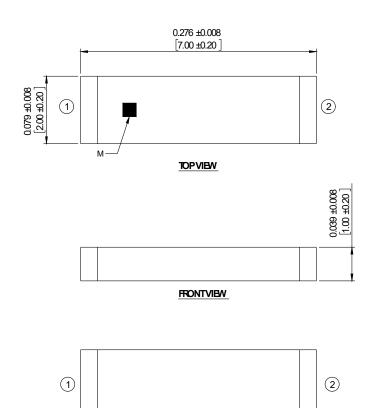


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7.0 x 2.0 x 1.0 mm **RoHS/RoHS II Compliant** MSL Level = 1

Product Dimensions and Terminal Configuration



BOTTOM VIEW

Symbol	Description
1	Antenna Feed
2	NC (not connected)
M	Mark

Unit: Inches [mm]



0.020 ±0.012

0.50 ±0.30



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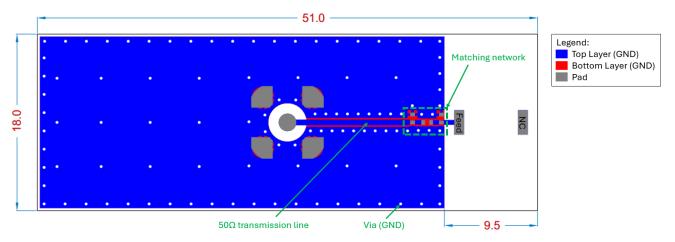
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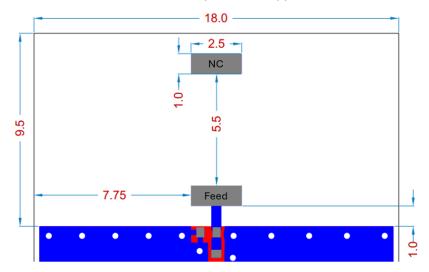
7.0 x 2.0 x 1.0 mm RoHS/RoHS II Compliant MSL Level = 1

Recommended PCB layout "AMCA72-2R470G-S1F-EVB"

If there are several layers in the PCB, there is an advantage to add vias for smooth interconnection of the ground areas to avoid splits in the ground plane. It is also important that the ground clearance is respected through all layers of the PCB. It is recommended to implement a matching network to optimize the antenna impedance in your application.



Rotated detailed view of antenna pads and copper clearance:



Unit: mm

Transmission Line

The transmission line should be kept as short as possible and be designed to have a characteristic impedance of 50Ω . Abracon recommends using a Co-Planar Waveguide with Ground (CPWG), which dimensions can be derived by any trusted calculator, using the correct input for PCB materials and layer stack-up.



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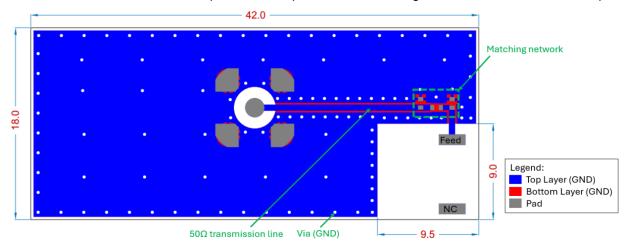


7.0 x 2.0 x 1.0 mm RoHS/RoHS II Compliant MSL Level = 1

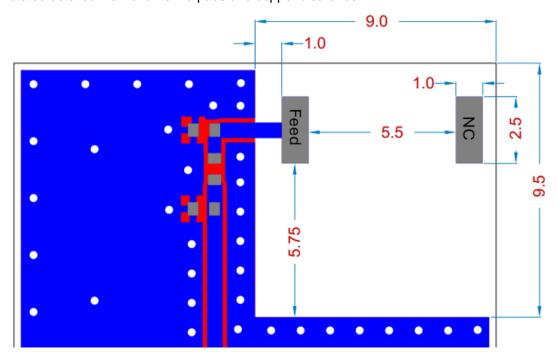
Alternative PCB layout "Corner Mount"

If there are several layers in the PCB, there is an advantage to add vias for smooth interconnection of the ground areas to avoid splits in the ground plane. It is also important that the ground clearance is respected through all layers of the PCB. It is recommended to implement a matching network to optimize the antenna impedance in your application.

The transmission line should be kept as short as possible and be designed to have a characteristic impedance of 50Ω .



Rotated detailed view of antenna pads and copper clearance:



Unit: mm





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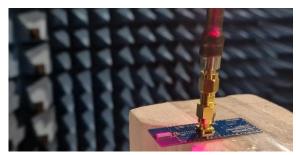
Check Inventory



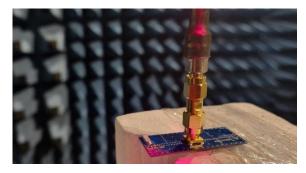
7.0 x 2.0 x 1.0 mm RoHS/RoHS II Compliant MSL Level = 1

Measurement Setup

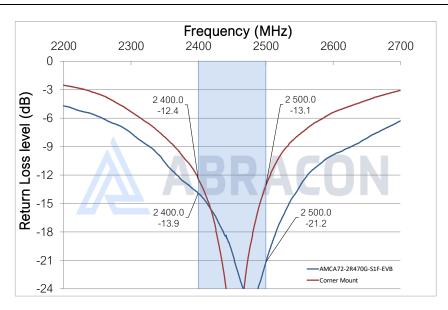
The antenna measurements were all done in free space, with the chip antenna implemented on its evaluation board (AMCA72-2R470G-S1F-EVB) that has a PCB size of 51 x 18 mm:



Measurements were also done with the antenna mounted on a PCB with the Alternative PCB layout "Corner Mount" that has a PCB size of 42 x 18 mm:



Reflection Characteristics – Return Loss





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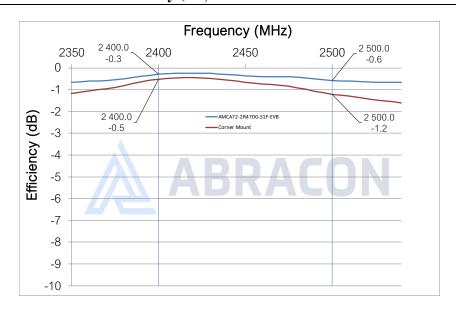


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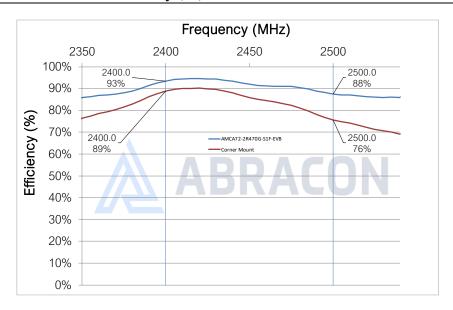


7.0 x 2.0 x 1.0 mm **RoHS/RoHS II Compliant** MSL Level = 1

Radiation Characteristics – Total Efficiency (dB)



Radiation Characteristics – Total Efficiency (%)







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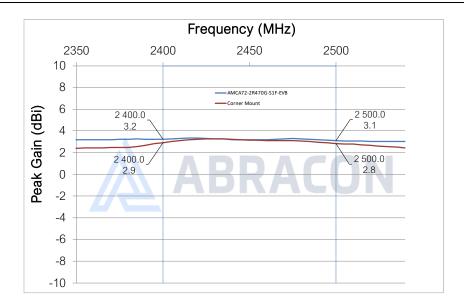


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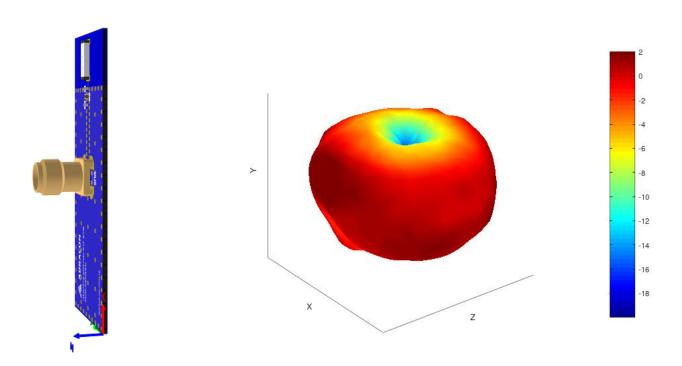


7.0 x 2.0 x 1.0 mm **RoHS/RoHS II Compliant** MSL Level = 1

Radiation Characteristics – Maximum Gain



Radiation Characteristics – 3D Pattern @ 2450 MHz (AMCA72-2R470G-S1F-EVB)



Unit: dBi



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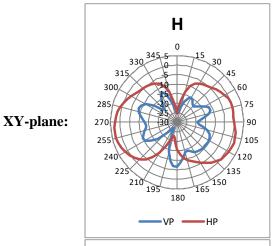


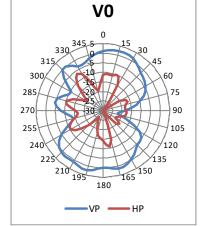
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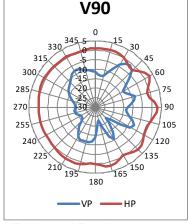


7.0 x 2.0 x 1.0 mm **RoHS/RoHS II Compliant** MSL Level = 1

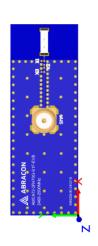
Radiation Characteristics – 2D Pattern @ 2450 MHz (AMCA72-2R470G-S1F-EVB)



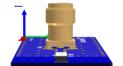




VP: Vertical Polarization HP: Horizontal Polarization







Unit: dBi



XZ-plane:

YZ-plane:

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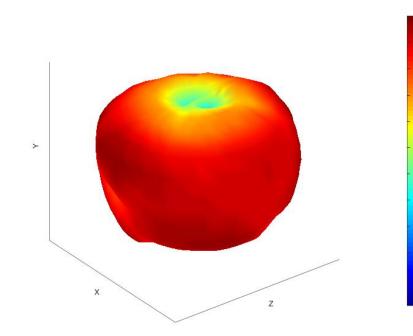
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7.0 x 2.0 x 1.0 mm RoHS/RoHS II Compliant MSL Level = 1

Radiation Characteristics – 3D Pattern @ 2450 MHz (Corner Mount)





Unit: dBi

-10

-14

-16 -18





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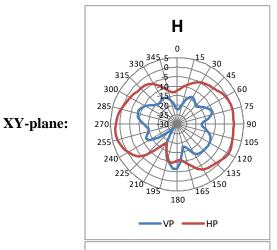


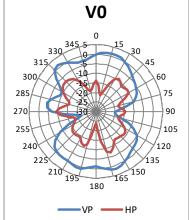
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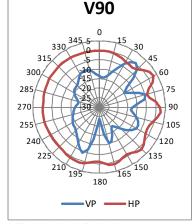


7.0 x 2.0 x 1.0 mm **RoHS/RoHS II Compliant** MSL Level = 1

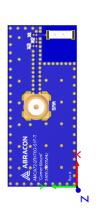
Radiation Characteristics – 2D Pattern @ 2450 MHz (Corner Mount)



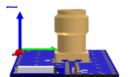




VP: Vertical Polarization HP: Horizontal Polarization







Unit: dBi



XZ-plane:

YZ-plane:

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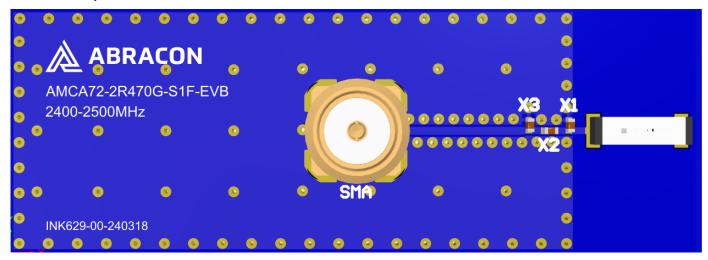
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7.0 x 2.0 x 1.0 mm RoHS/RoHS II Compliant MSL Level = 1

Evaluation Board Outline & Matching Circuit

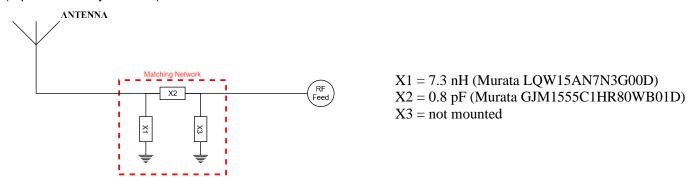
The evaluation board (AMCA72-2R470G-S1F-EVB) is developed to simplify antenna testing and evaluation. It has an arbitrary size of 51 x 18 mm and includes an SMA connector. The purpose is to give a reference design for an optimal antenna implementation. The evaluation board can also be used to test other implementations by cutting and soldering the PCB into any device.



Evaluation board outline

The evaluation board has a matching circuit implemented next to the antenna. This is aimed to enable optimization possibilities for the user. The component positions are sized for 0402 (1005 metric) SMD components.

The antenna requires a matching circuit to fine-tune the resonant frequency and achieve optimal balance. The evaluation board is pre-tuned for optimal performance in the 2.4–2.5 GHz range using the components listed below (equivalents may be used):



However, it is common that the resonant frequency will shift during implementation in an arbitrary device. Therefore, this matching may be changed with other values/components/brands for compensation of such effects. This is further described in the General Implementation Guidelines section below.





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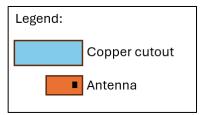


7.0 x 2.0 x 1.0 mm **RoHS/RoHS II Compliant** MSL Level = 1

General Implementation Guidelines

The antenna can be positioned in different ways, although there are some positions which are more beneficial. The below illustration shows a typical PCB with examples on different antenna positions; where option 1 typically yields slightly better performance, and option 2 uses less space of the PCB.





The rectangular copper cutout in the footprint must extend through all layers of the PCB stack-up, ensuring there is **no** copper on any layer in this area. Additionally, a robust via structure around the cutout and along the edge of the ground plane is highly recommended for optimal performance.

It is important to note that plastic and metal parts in close proximity to antennas may significantly affect antenna tuning and performance. For instance, a plastic housing above the antenna often causes the resonant frequency to shift downward. Since such effects are challenging to predict without detailed design information, it is recommended to measure the antenna performance in the final device after implementation. To compensate for potential frequency shifts, implementing a matching network on the antenna feed is advisable.

Another general consideration for surface-mounted antennas relates to PCB population. Electrical components placed near the antenna may impact its tuning and radiation performance. To mitigate this, components in the surrounding area should be positioned below a topographical slope. This slope should begin at the PCB level near the antenna's designated keep-out zone and gradually increase in height as distance from the antenna grows.

For technical assistance, please contact Abracon online support through our online support platform.





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Reflow Profile [JEDEC J-STD-020]

Solder paste: Sn/3.0Ag/0.5Cu

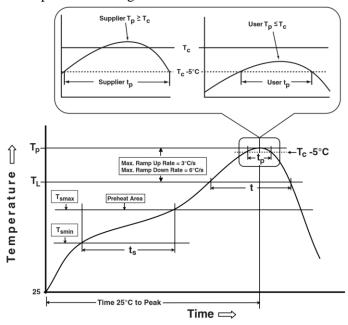


Table 1

SnPb Eutectic Process Classification Temperatures (T _c)					
Package Volume mm³ Volume mm³ Thickness <350 ≥350					
<2.5mm	235°C	220°C			
≧2.5mm	220°C	220°C			

Table 2

Pb-Free Process Classification Temperatures (T _c)							
PackageVolume mm³Volume mm³Volume mm³Thickness<350350-2000>2000							
<1.6mm	260°C	260°C	260°C				
1.6mm - 2.5mm	260°C	250°C	245°C				
>2.5mm	250°C	245 ℃	245 ℃				

Profile Feature	Sn-Pb Eutectic Assembly	Pb-Free Assembly
Preheat / soak		
Temperature minimum (T _{smin})	100°C	150°C
Temperature maximum (T _{smax})	150°C	200°C
Time $(T_{smin} \text{ to } T_{smax}) (t_s)$	60 – 120 sec.	60 – 90 sec.
Average ramp-up rate (T _{smax} to T _p)	3°C/sec. max	3°C/sec. max
Liquidous temperature (T _L)	183°C	217°C
Time at Liquidous (T _L)	60 – 150 sec.	60 – 150 sec.
Peak package body temperature (T _p)*	See Table 1	See Table 2
Time $(T_p)^{**}$ within 5°C of the specified classification temperature (T_c)	20 sec.	10 sec.
Ramp-down rate (T _p to T _{smax})	6°C/sec. max	6°C/sec. max
Time 25°C to peak temperature	6 min. max	8 min. max
Reflow cycles	2 max	2 max

^{*}Tolerance for peak profile temperature (Tp) is defined as a supplier minimum and a user maximum.



^{**}Tolerance for time at peak profile temperature (tp) is defined as a supplier minimum and a user maximum.



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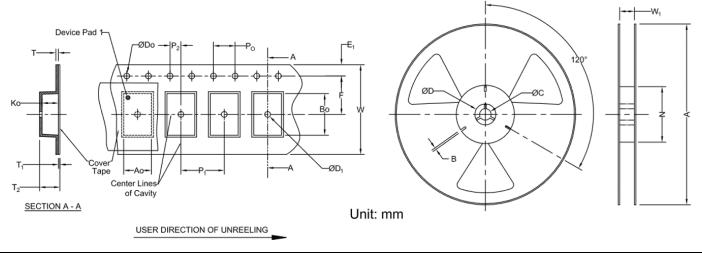
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7.0 x 2.0 x 1.0 mm **RoHS/RoHS II Compliant** MSL Level = 1

Packaging

Tape & Reel dimensions:



Carrier Tape Specifications (mm)								
Do	Do K ₀ E ₁ P ₀ T F P ₁ W A ₀ B ₀ Reel Qty							Reel Qty
$1.50 + 0.1 1.0 \pm 0.1 1.75 \pm 0.1 4.0 \pm 0.1 0.3 \pm 0.05 7.5 \pm 0.15 8.0 \pm 0.1 16.0 \pm 0.1 2.3 \pm 0.1 7.5 \pm 0.1 4,000$								

Reel Specifications (mm)							
A W ₁ N B C							
330 ± 1 16.5 ± 0.2 100 ± 0.5 2.3 ± 0.2 13.5 ± 0.2							

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